



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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P/1071-1329

OCT 14 2001

TECHNOLOGY CENTER 2000

In re Patent Application of

Kenichi HAMANAKA, et al.

Date: October 2, 2001

Serial No.: 09/854,767

Group Art Unit: 2832

Filed: May 14, 2001

For: ADHESIVE RESIN COMPOSITION AND METHOD OF PRODUCING THE SAME,
AND CHIP COIL COMPONENT

Asst. Commissioner for Patents
Washington, D.C. 20231

REQUEST FOR A CORRECTED FILING RECEIPT

Sir:

Please issue a corrected filing receipt for the above application. The original filing receipt includes the following errors:

- ☒ Each inventor's address is wrong. Please correct to read as follows: --Kenichi HAMANAKA, Omihachiman-shi, JAPAN; Kunisaburo TOMONO, Otsu-shi, JAPAN; Akihiko KAWAKAMI, Kouka-gun, JAPAN--. A copy of the original declaration showing the correct inventorship is enclosed.
- ☒ The title of the invention is incorrect. Please correct "same, chip" to read --same, and chip--. A copy of the original declaration setting forth the correct title is enclosed.

It is requested that the U.S. Patent and Trademark Office issue a corrected filing receipt at the earliest possible date.

In the event payment of any fee is inadvertently not enclosed, or if any additional fee during the prosecution of this case is not paid, the Patent and Trademark Office is authorized to charge the underpayment to Deposit Account No. 15-0700.

Respectfully submitted,



Edward A. Meilman

Registration No.: 24,735

OSTROLENK, FABER, GERB & SOFFEN, LLP

1180 Avenue of the Americas

New York, New York 10036-8403

Telephone: (212) 382-0700

EAM:mgs
Enclosure